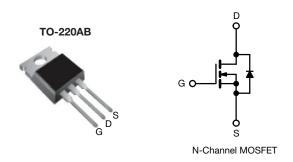
SiHP21N80AEF



Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.220			
Q _g max. (nC)	71				
Q _{gs} (nC)	10				
Q _{gd} (nC)	21				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SIHP21N80AEF-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	800	v		
Gate-source voltage			V _{GS}	± 30	v		
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	16.3			
	VGS AL TO V	T _C = 100 °C		10.3	А		
Pulsed drain current ^a			I _{DM}	37			
Linear derating factor				1.4	W/°C		
Single pulse avalanche energy ^b			E _{AS}	127	mJ		
Maximum power dissipation			PD	179	W		
Operating junction and storage temperature rar	ige		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope		T _J = 125 °C	100				
Reverse diode dv/dt ^d		dv/dt	50	V/ns			
Soldering recommendations (peak temperature) c	For 10 s		260	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.0 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 170 A/µs, starting T_J = 25 °C



COMPLIANT

HALOGEN

FREE



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-		62				
Maximum junction-to-case (drain)	R _{thJC}	- 0.7				°C/W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherw	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static							1	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 μA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	2.0	-	4.0	V
		,	$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA
Gate-source leakage	I _{GSS}	,			-	-	± 1	μA
7			= 640 V, V _{GS}		-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	', V _{GS} = 0 V	, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D	= 8.5 A	-	0.220	0.250	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D =	11 A	-	8.7	-	S
Dynamic					•	•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1511	-	pF	
Output capacitance	C _{oss}			-	58	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}			-	44	-		
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	271	-	
Total gate charge	Qg				-	47	71	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 11 A, V _{DS} = 640 V		-	10	-	nC
Gate-drain charge	Q _{gd}				-	21	-	1
Turn-on delay time	t _{d(on)}	V _{DD} = 640 V, I _D = 11 A,		-	18	36		
Rise time	t _r			-	28	56	1	
Turn-off delay time	t _{d(off)}	V _{GS} =	$V_{\rm GS} = 10 \text{ V}, \text{ R}_{\rm g} = 9.1 \Omega$		-	44	88	ns
Fall time	t _f	1		-	43	86		
Gate input resistance	Rg	f = 1 MHz, open drain		0.2	0.5	1.0	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	16.3		
Pulsed diode forward current	I _{SM}			-	-	37	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		-	128	256	ns	
Reverse recovery charge	Q _{rr}			-	0.8	1.6	μC	
Reverse recovery current	I _{RRM}			-	12	-	A	

Notes

e. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V

f. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

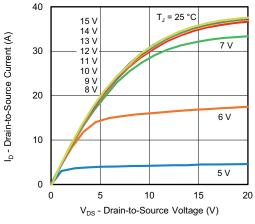


Fig. 1 - Typical Output Characteristics

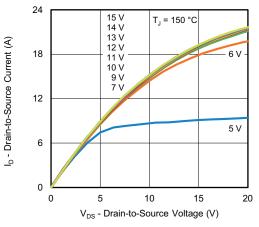


Fig. 2 - Typical Output Characteristics

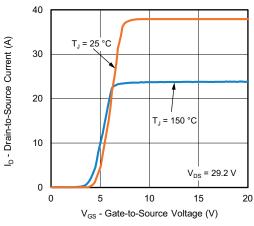


Fig. 3 - Typical Transfer Characteristics

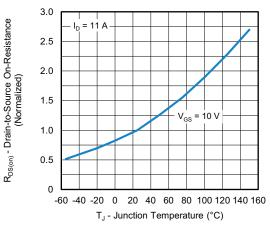


Fig. 4 - Normalized On-Resistance vs. Temperature

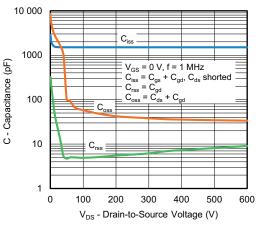
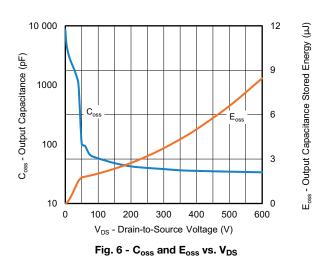


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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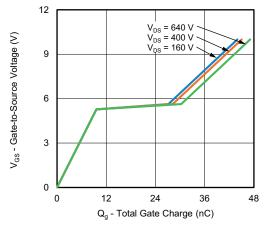


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

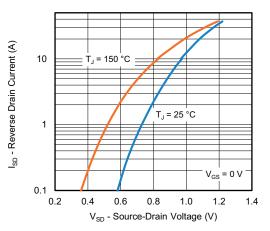


Fig. 8 - Typical Source-Drain Diode Forward Voltage

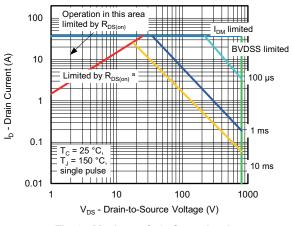


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

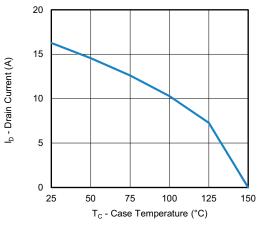


Fig. 10 - Maximum Drain Current vs. Case Temperature

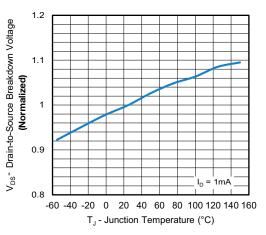


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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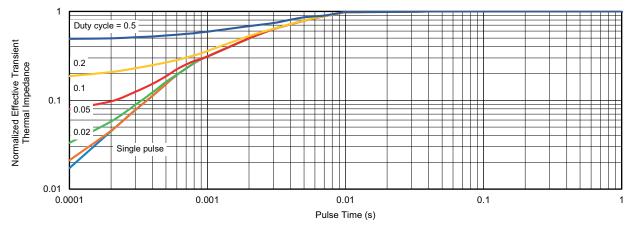


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

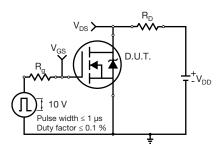


Fig. 13 - Switching Time Test Circuit

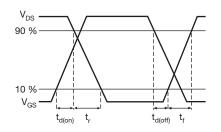


Fig. 14 - Switching Time Waveforms

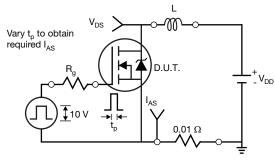


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

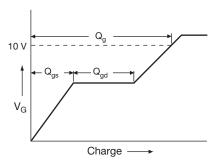


Fig. 17 - Basic Gate Charge Waveform

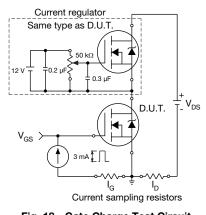


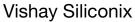
Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

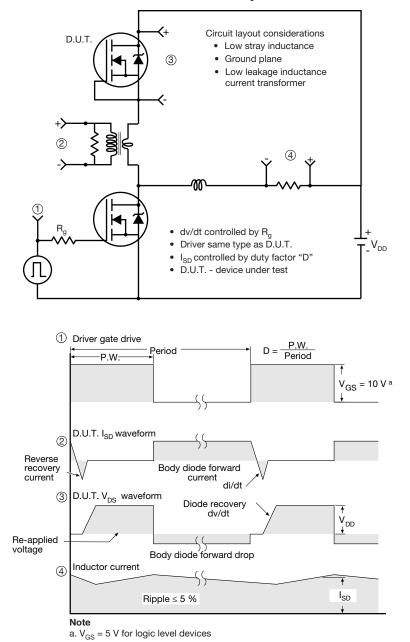


Fig. 19 - For N-Channel

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Revision: 01-Jan-2025

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